

FCH077N65F F085

N-Channel SuperFET II FRFET MOSFET **650 V, 54 A, 77 m**Ω

Features

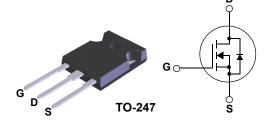
- Typical $R_{DS(on)}$ = 68 m Ω at V_{GS} = 10 V, I_D = 27 A
- Typical $Q_{q(tot)}$ = 126 nC at V_{GS} = 10V, I_D = 27 A
- UIS Capability
- Qualified to AEC Q101
- RoHS Compliant

Description

automotive.

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV-EV

SuperFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



For current package drawing, please refer to the Fairchild website at https://www.fairchildsemi.com/package-drawings/TO/ TO247A03.pdf

Application

- Automotive On Board Charger
- Automotive DC/DC converter for HEV



December 2014

Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Paramete	Ratings	Units	
V_{DSS}	Drain to Source Voltage		650	V
V_{GS}	Gate to Source Voltage		±20	V
	Drain Current - Continuous (V _{GS} =10) (No	ote 1)	54	Α
ID	Pulsed Drain Current		See Fig 4	Α
E _{AS}	Single Pulse Avalanche Rating	(Note 2)	1128	mJ
dv/dt	MOSFET dv/dt		100	V/ns
uv/ui	Peak Diode Recovery dv/dt	(Note 3)	50	V/IIS
Б	Power Dissipation		481	W
P_D	Derate Above 25°C		3.85	W/°C
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 150	οС
$R_{\theta JC}$	Maximum Thermal Resistance Junction to Case		0.26	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to	Ambient (Note 4)	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH077N65F	FCH077N65F_F085	TO-247	-	-	30

Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting T_J = 25°C, L = 18.65mH, I_{AS} = 11A, V_{DD} = 100V during inductor charging and V_{DD} = 0V during time in avalanche. 3: I_{SD} ≤ 27A, di/dt ≤ 200 A/us, V_{DD} ≤ 380V, starting T_J = 25°C.
- 4: R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Units

Max

Тур

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter

Off Cha	Off Characteristics						
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, \	/ _{GS} = 0V	650	-	-	V
	Desirate Course Leakage Current	V _{DS} =650V,	$T_{\rm J} = 25^{\rm o}{\rm C}$	-	-	10	μА
I _{DSS} Drain to Source Leakage Current		$V_{GS} = 0V$	$T_{\rm J} = 150^{\rm o} C({\rm Note} \ 5)$	-	-	1	mA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

Test Conditions

Min

On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		3.0	-	5.0	V
r	Drain to Source On Resistance	I _D = 27A,	$T_{J} = 25^{\circ}C$	-	68	77	$m\Omega$
r _{DS(on)} Drain to Source On Resistance	$V_{GS} = 10V$	$T_J = 150^{\circ}C(Note 5)$	-	154	184	mΩ	

Dynamic Characteristics

C _{iss}	Input Capacitance	051/1/	-	5385	7162	pF
C _{oss}	Output Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz	-	5629	7486	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1101112	-	194	-	pF
C _{oss(eff)}	Effective Output Capacitance	V_{DS} = 0V to 520V, V_{GS} = 0V	-	693	-	pF
R_g	Gate Resistance	f = 1MHz	-	0.5	-	Ω
$Q_{g(ToT)}$	Total Gate Charge	.,	-	126	164	nC
$Q_{g(th)}$	Threshold Gate Charge	V _{DD} = 380V I _D = 27A	-	9	12	nC
Q_{gs}	Gate to Source Gate Charge	$V_{GS} = 10V$	-	28	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	1.05	-	53	-	nC

Switching Characteristics

t _{on}	Turn-On Time		-	64	148	ns
t _{d(on)}	Turn-On Delay Time		-	37	-	ns
t _r	Rise Time	V _{DD} = 380V, I _D = 27A,	-	27	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_G = 4.7\Omega$	-	105	-	ns
t _f	Fall Time		-	5.3	-	ns
t _{off}	Turn-Off Time		-	108.3	237	ns

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	I _{SD} = 27A, V _{GS} = 0V	-	-	1.2	V
T _{rr}	Reverse Recovery Time	$I_F = 27A$, $dI_{SD}/dt = 100A/\mu s$	1	190	1	ns
Q _{rr}	Reverse Recovery Charge	V _{DD} = 520V	-	1.5	-	μС

Notes:

5: The maximum value is specified by design at T_J = 150°C. Product is not tested to this condition in production.

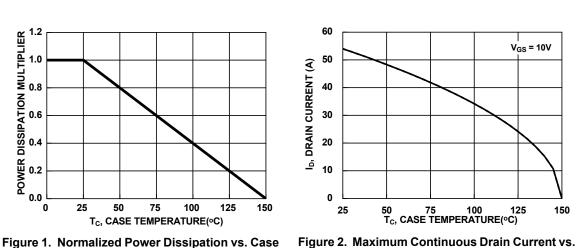
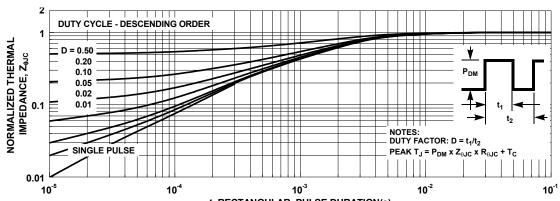


Figure 1. Normalized Power Dissipation vs. Case Temperature

Typical Characteristics

Figure 2. Maximum Continuous Drain Current vs.

Case Temperature



t, RECTANGULAR PULSE DURATION(s)
Figure 3. Normalized Maximum Transient Thermal Impedance

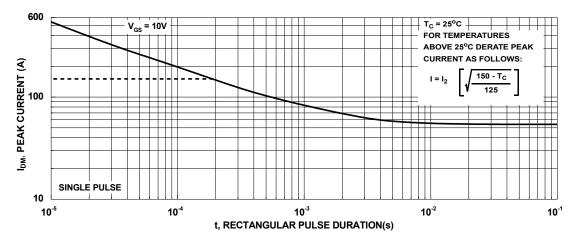


Figure 4. Peak Current Capability

Typical Characteristics

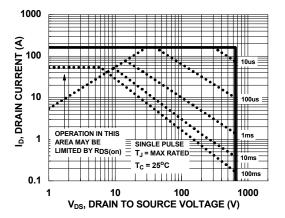


Figure 5. Forward Bias Safe Operating Area

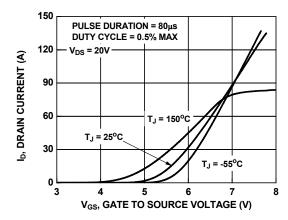


Figure 6. Transfer Characteristics

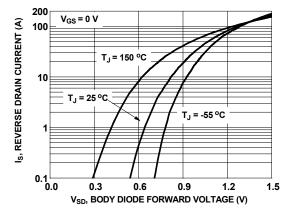


Figure 7. Forward Diode Characteristics

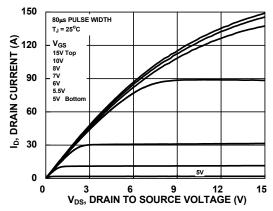


Figure 8. Saturation Characteristics

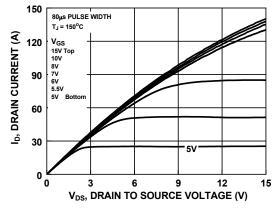


Figure 9. Saturation Characteristics

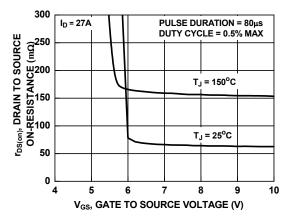


Figure 10. R_{DSON} vs. Gate Voltage

Typical Characteristics

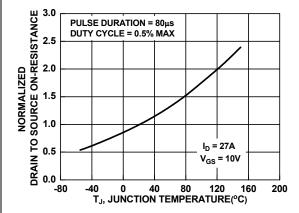


Figure 11. Normalized R_{DSON} vs. Junction Temperature

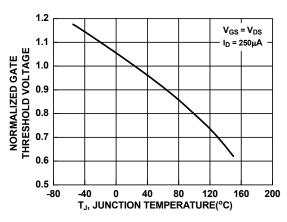


Figure 12. Normalized Gate Threshold Voltage vs.
Temperature

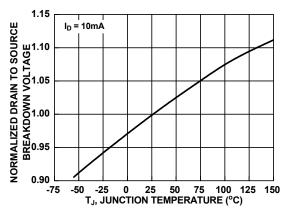


Figure 13. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

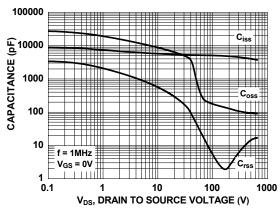


Figure 14. Capacitance vs. Drain to Source Voltage

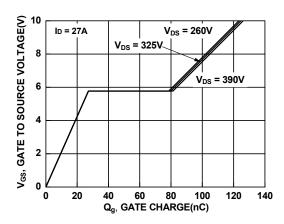


Figure 15. Gate Charge vs. Gate to Source Voltage

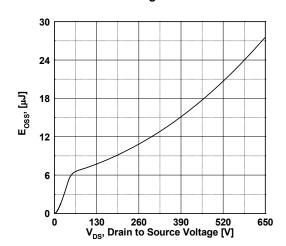


Figure 16. Eoss vs. Drain to Source Voltage

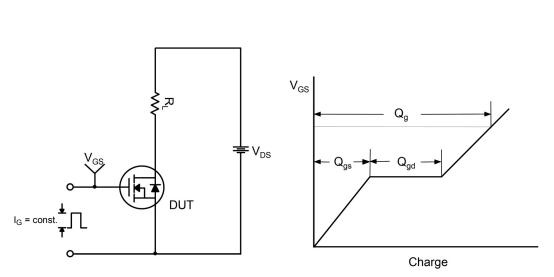


Figure 17. Gate Charge Test Circuit & Waveform

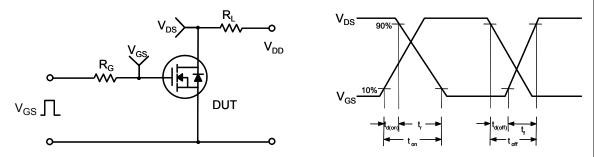


Figure 18. Resistive Switching Test Circuit & Waveforms

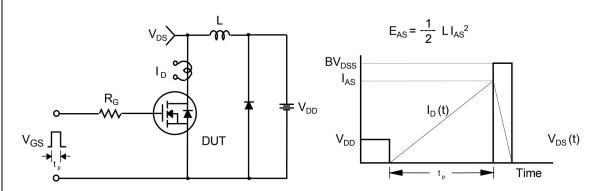
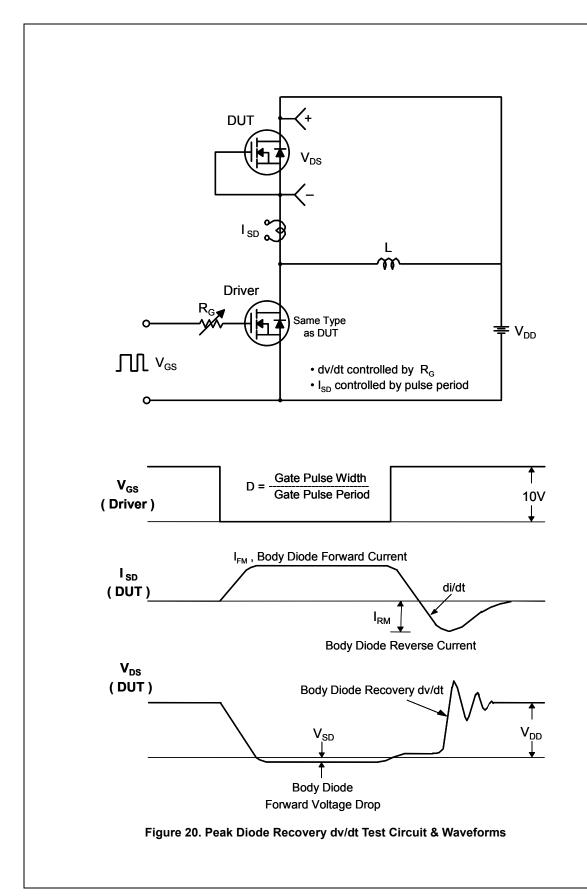


Figure 19. Unclamped Inductive Switching Test Circuit & Waveforms



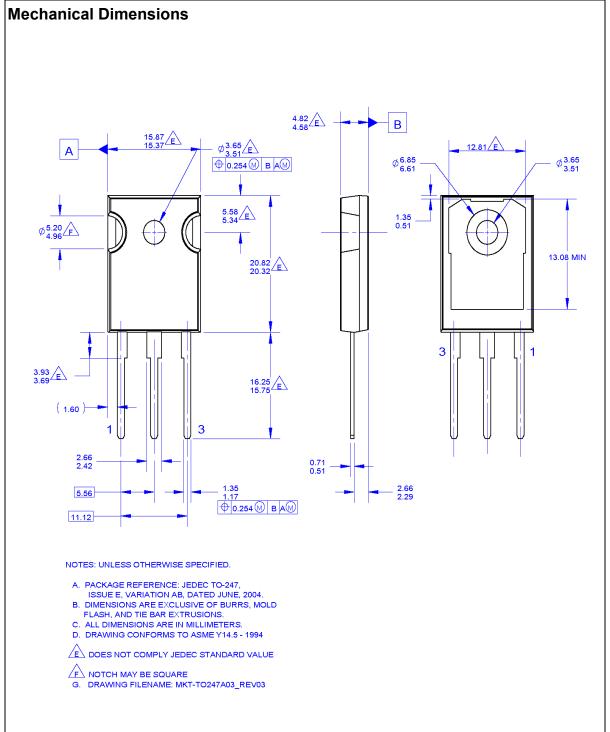


Figure 21. TO-247, Molded, 3-Lead, Jedec Variation AB

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